

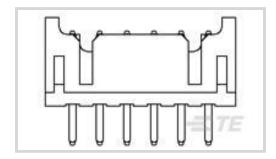
## AMPMODU | AMPMODU 2 mm

TE Internal #: 1-1470109-4 PCB Mount Header, Vertical, Wire-to-Board, 14 Position, 2 mm [. 079 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Signal, AMPMODU 2 mm

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Connectors > PCB Connectors > PCB Headers & Receptacles



### Connector System: Wire-to-Board

Number of Positions: 14

Number of Rows: 2

Centerline (Pitch): 2 mm [.079 in ]

PCB Mount Orientation: Vertical

## Features

## **Product Type Features**

Connector SystemWire-to-BoardHeader TypeFully ShroudedConnector & Contact Terminates ToPrinted Circuit Board

PCB Connector Assembly Type

PCB Mount Header

## **Configuration Features**

Board-to-Board Configuration	Parallel
Connector Contact Load Condition	Fully Loaded
Number of Positions	14
Number of Rows	2
PCB Mount Orientation	Vertical
Electrical Characteristics	
Dielectric Withstanding Voltage (Max)	750 VAC
Insulation Resistance	5000 ΜΩ
Operating Voltage	100 VDC
Body Features	
Primary Product Color	Natural
Contact Features	
Contact Mating Area Length	3 mm[.1 in][.138 in]

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PCB Mount Header, Vertical, Wire-to-Board, 14 Position, 2 mm [.079 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Signal, AMPMODU 2 mm



Mating Square Post Dimension	5  mm[02  m]
Mating Square Post Dimension	.5 mm[.02 in]
	100 µin
Contact Layout	
Contact Mating Area Plating Material Thickness	2.54 μm[100 μin]
Contact Shape & Form	Square
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Brass
Contact Mating Area Plating Material	Tin
Contact Type	Pin
Contact Current Rating (Max)	3 A
Termination Features	
Square Termination Post & Tail Dimension	.5 mm[.02 in]
Termination Post & Tail Length	3 mm[.118 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mating Alignment Type	Keyed
Connector Mounting Type	Board Mount
Mating Alignment	With
PCB Mount Alignment	Without
PCB Mount Retention	Without
Housing Features	
Housing Material	High Temperature Thermoplastic
Centerline (Pitch)	2 mm[.079 in]
Dimensions	
Connector Height	6.5 mm
PCB Thickness (Recommended)	1.57 mm[.062 in]
Row-to-Row Spacing	2 mm[.079 in]
Jsage Conditions	
Operating Temperature Range	-25 – 85 °C[-13 – 185 °F]
Operation/Application	
Circuit Application	Signal
ndustry Standards	

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Approved Standards	CSA LR7189, UL E28476
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Type	Bag, Carton
Other	
Position Locations Omitted	0
<b>Product Compliance</b> For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free

## Solder Process Capability

### Not lead free process capable

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

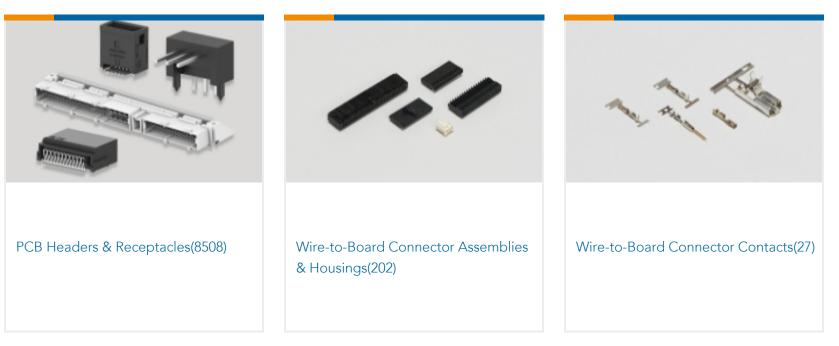
## **Compatible Parts**

PCB Mount Header, Vertical, Wire-to-Board, 14 Position, 2 mm [.079 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Signal, AMPMODU 2 mm

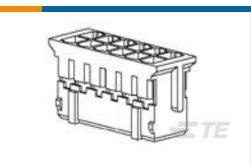




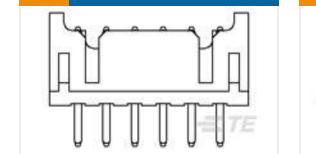
## Also in the Series AMPMODU 2 mm



# Customers Also Bought











## Documents

## Product Drawings

2.0mm Pitch Header,Dip 14p

English

## **CAD** Files

Customer View Model ENG\_CVM\_CVM\_1-1470109-4\_E.2d\_dxf.zip

PCB Mount Header, Vertical, Wire-to-Board, 14 Position, 2 mm [.079 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Signal, AMPMODU 2 mm



English

3D PDF

3D

Customer View Model

ENG\_CVM\_CVM\_1-1470109-4\_E.3d\_igs.zip

English

Customer View Model

ENG\_CVM\_CVM\_1-1470109-4\_E.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages AMPMODU\_INTERCONNECTION\_SYSTEM\_SECTION3AND4

English

HPI Connectors QRG

English

**Product Specifications** 

**Product Specification** 

English

**Product Specification** 

English